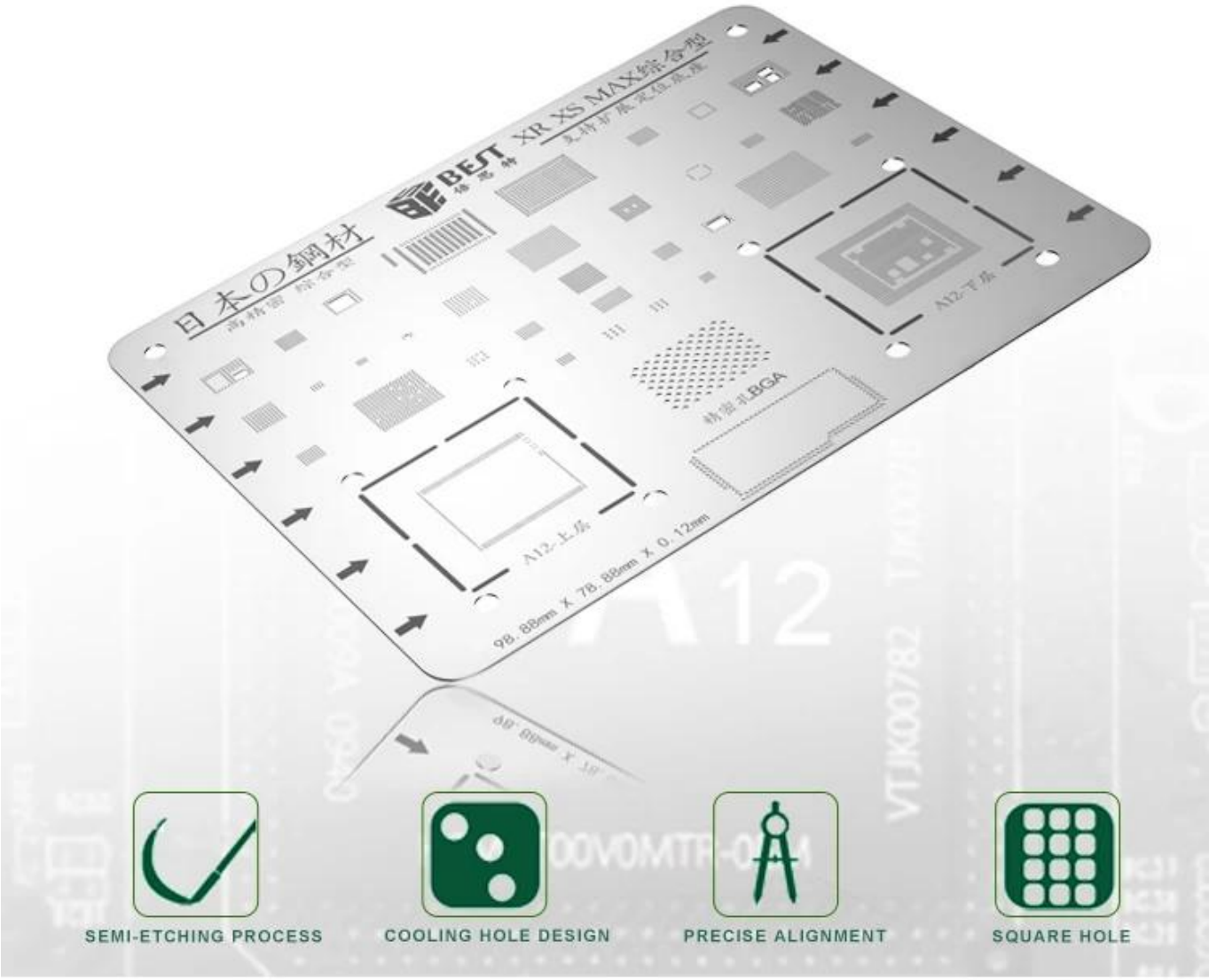
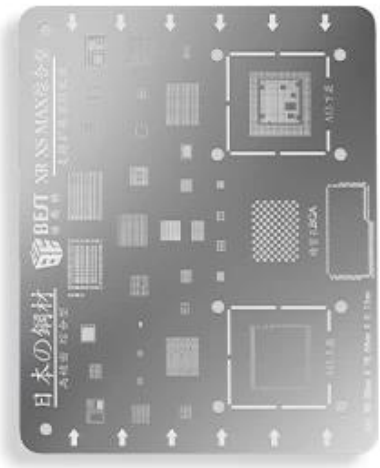
REBALLING STENCIL

— iPhone CPU series —



Product Usage



MATERIAL	Imported steel
BRAND	BESTOOL
PRODUCT NAME	Reballing Stencil
WEIGHT	7g /3.8g
TYPE	Precise alignment Strong toughness Non-stick ti

▼PRODUCT CHARACTIERISTICS

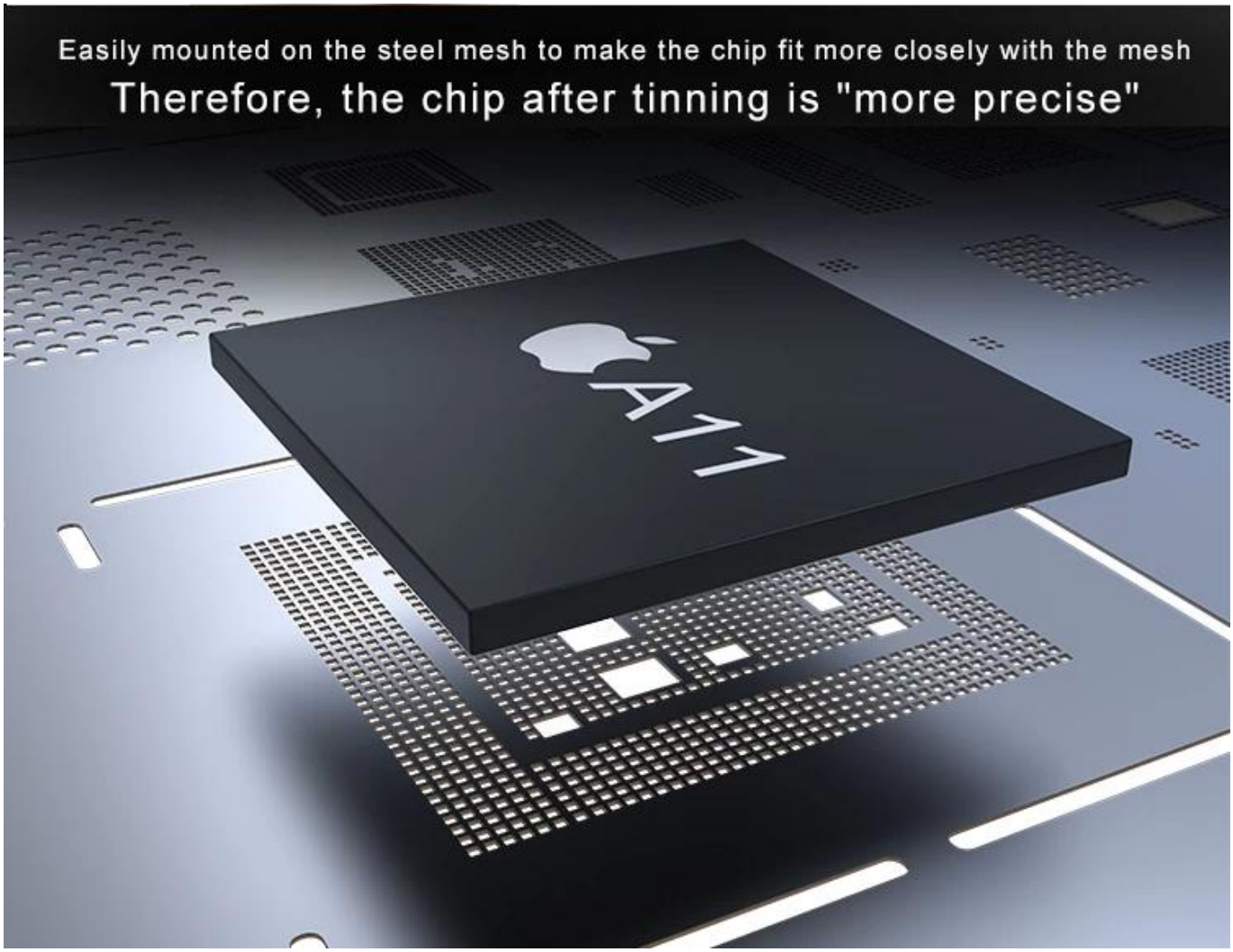
This product is used for BGA tinning repair of iPhone series. It adopts imported steel material, anti-rolling anti-deformation, automatic alignment, precise hole position, non-stick tin, good toughness and off-grid.

PRODUCT INFORMATION

IMPORTED STEEL

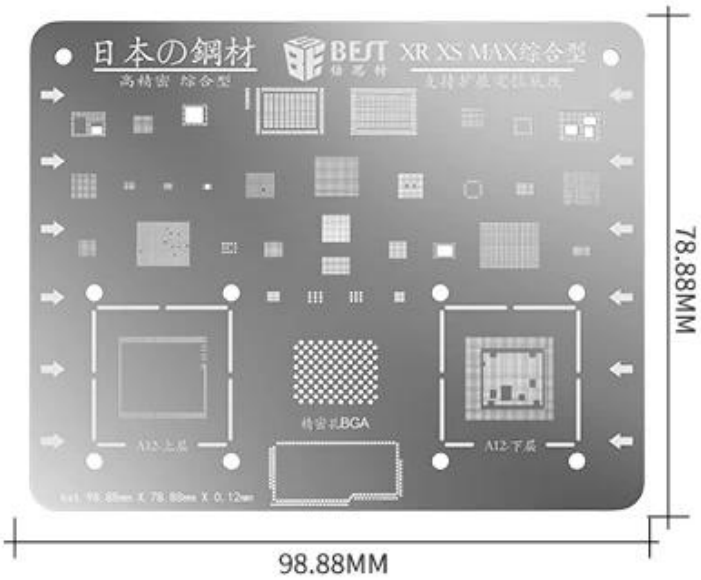
HIGH TOUGHNESS

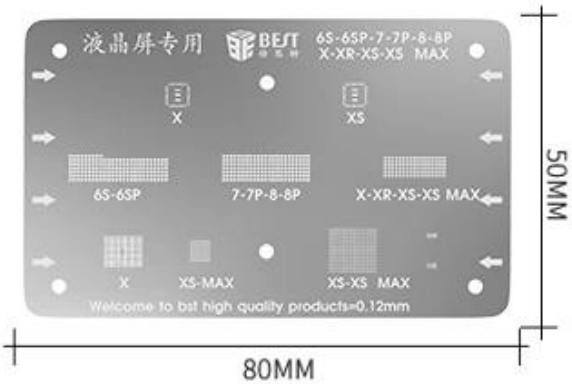
GOOD PRODUCTS ARE NOT ONLY EXCELLENT FORGING PROCESSES, BUT THE REAL CORE LIES IN THE SELECTION OF DELICATE MATERIALS.


Easily mounted on the steel mesh to make the chip fit more closely with the mesh
Therefore, the chip after tinning is "more precise"
A11

Imported steel
Hard and wear resistant
Accurate to the hole

PRODUCT SIZE



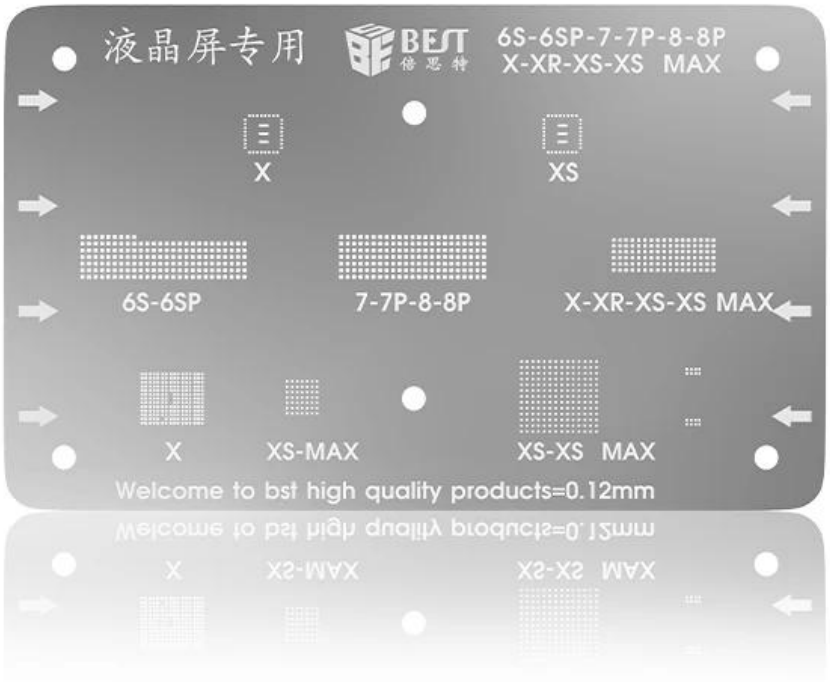


Thin to 0.12mm

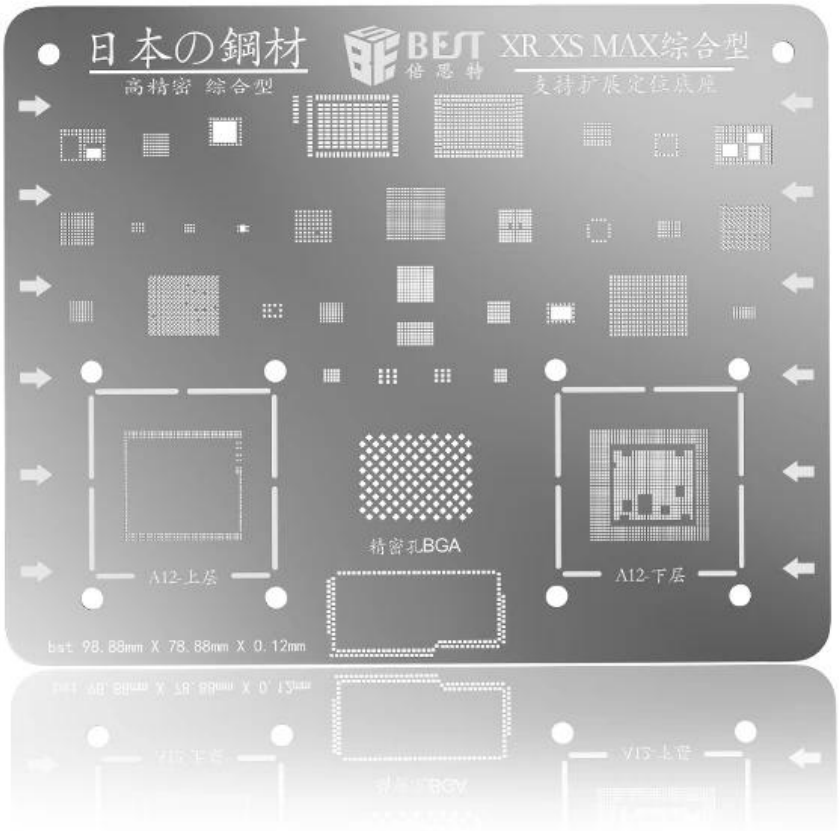
Precise die-casting Iform heating

0.12
mm
OFF/ON
ZERO
70
80
90
100
110
120

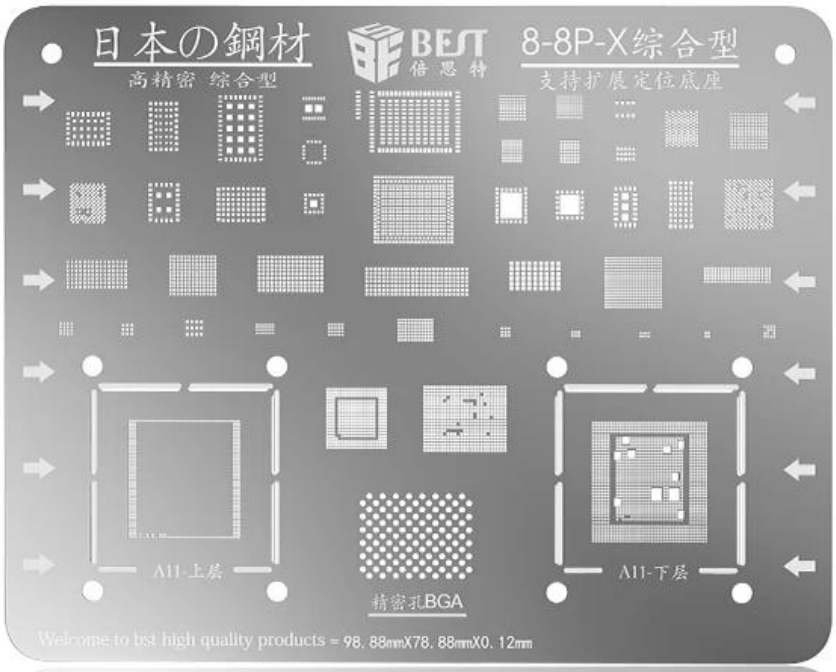
6S-6SP-7-7P-8-8P-X-XR-XS-XS MAX



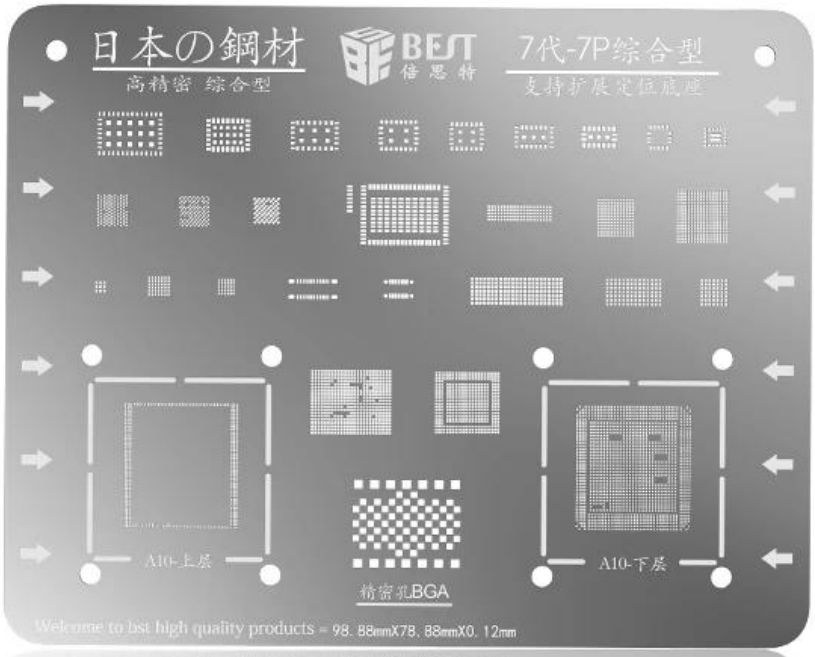
XR-XS-XS MAX COMPREHENSIVE



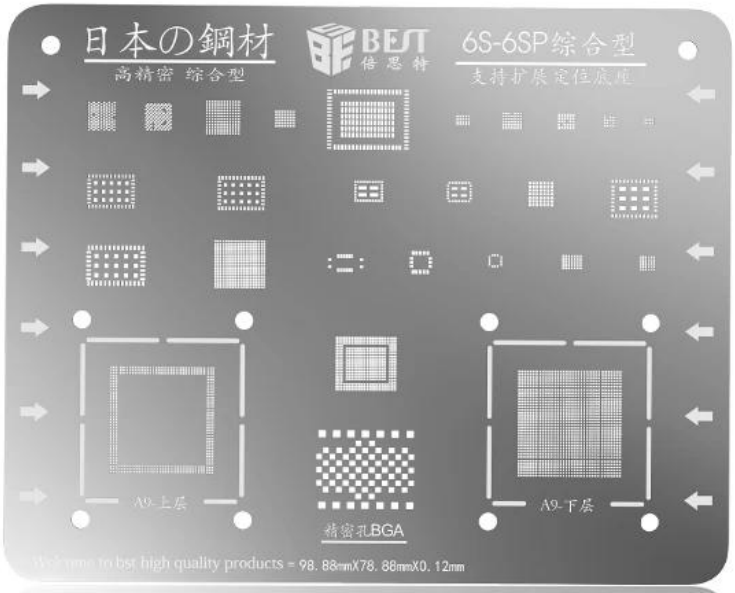
8-8P-X COMPREHENSIVE



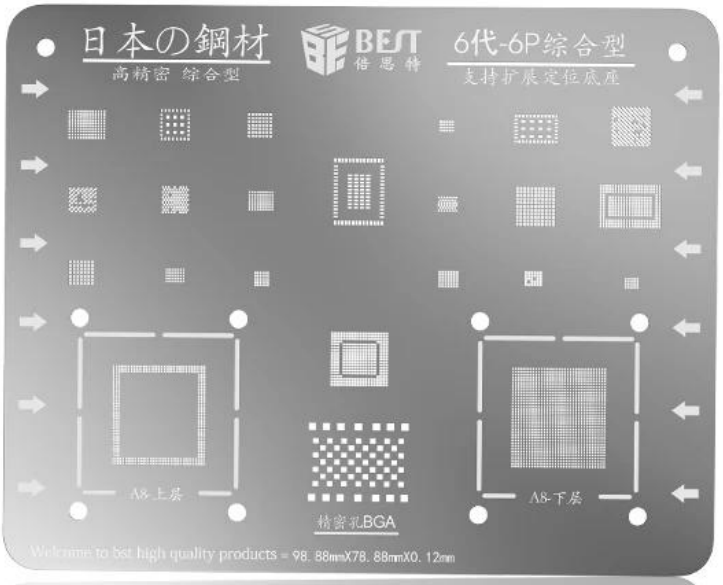
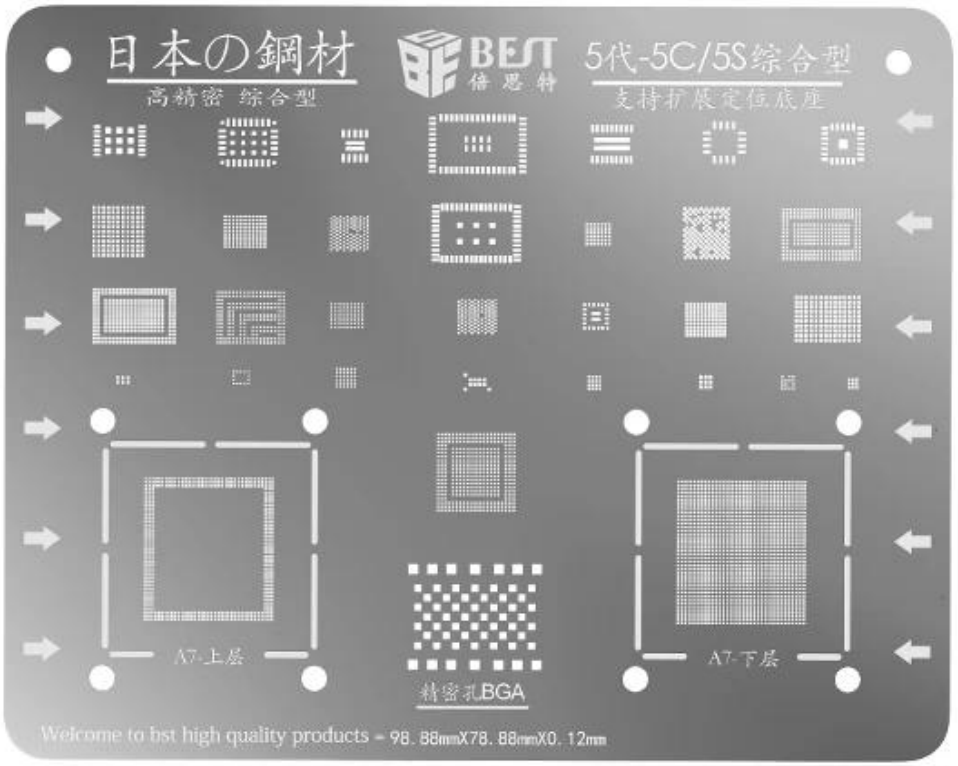
7-7P COMPREHENSIVE



6S-6SP COMPREHENSIVE



6-6P COMPREHENSIVE



5-5C/5S COMPREHENSIVE